

#### **SSC8028GT8**

#### **N-Channel Enhanced MOSFET**

#### > Features

VDS	VGS	RDSON Typ.	ID
20V	+12V	3.1mR@4.5V	
	ΞΙΖV	4.2mR@2.5V	106A

#### Description

This device is N-Channel enhancement MOSFET. Uses advanced trench technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit. 100%UIS+DVDS+Rg Test.

## Applications

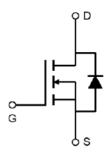
- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

## Ordering Information

Device	Package	Shipping
SSC8028GT8	TO-252	2500/Reel

## > Pin Configuration







Marking

(XX: Product Year/YY: Product Week)



## ➤ Absolute Maximum Ratings(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit		
V <sub>DSS</sub>	Drain-to-Source Voltage		20	V	
V <sub>GSS</sub>	Gate-to-Source Volt	age	±12	V	
1	0 1 0 0 1 1	T <sub>C</sub> =25°C	106		
l <sub>D</sub>	Continuous Drain Current d	in Current d $T_{c}=100^{\circ}C$ in Current a $T_{A}=25^{\circ}C$ $T_{A}=70^{\circ}C$ seed Drain Current b  pation c $T_{c}=100^{\circ}C$	52	Α	
	I <sub>DSM</sub> Continuous Drain Current <sup>a</sup>	T <sub>A</sub> =25°C	40		
IDSM		T <sub>A</sub> =70°C	26	A	
$I_{DM}$	Pulsed Drain Curre	424	Α		
Б	Power Dissipation c	Tc=25°C	62	10/	
$P_D$		Tc=100°C	25	W	
Б	D Distribution 2	T <sub>A</sub> =25°C	8.9	10/	
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	T <sub>A</sub> =70°C	5.7	W	
las	Avalanche Current b L=0.5ml	29	Α		
Eas	Avalanche Energy b L=0.5mH Single Pulse		210	mJ	
TJ	Operation junction temperature		-55~150	96	
T <sub>STG</sub>	Storage temperature	-55~150	°C		

## ➤ Thermal Resistance Ratings(T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R <sub>0JA</sub>	Junction-to-Ambient Thermal Resistance <sup>a</sup>	14	°C/W
Rejc	R <sub>0JC</sub> Junction-to-Case Thermal Resistance		C/ W

#### Note:

- a. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with  $T_A$ =25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t  $\leq$  10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation  $P_D$  is based on  $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

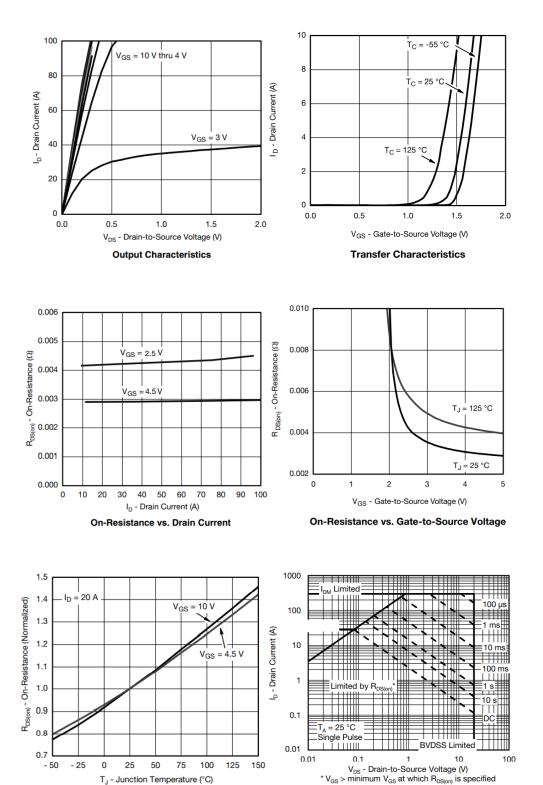


# ➤ Electronics Characteristics(T<sub>A</sub>=25 °C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	VGS=0V, ID=250uA	20			٧
V <sub>GS (th)</sub>	Gate Threshold Voltage	VDS=VGS, ID=250uA	0.5	0.7	1	V
	Drain-Source On-	VGS=4.5V, ID=20A		3.1	5	D
R <sub>DS(on)</sub>	Resistance	VGS=2.5V, ID=15A		4.2	7	mR
I <sub>DSS</sub>	Zero Gate Voltage Drain  Current	VDS=20V, VGS=0V			1	uA
I <sub>GSS</sub>	Gate-Source leak current	VGS=±12V, VDS=0V			±100	nA
G <sub>FS</sub>	Transconductance	VDS=5V, ID=5A		25		S
V <sub>SD</sub>	Forward Voltage	VGS=0V, IS=10A		0.78	1.3	V
Rg	Gate Resistance	VGS=0V, f=1MHz		2	3	R
Ciss	Input Capacitance			2040		
Coss	Output Capacitance	VDS=10V, VGS=0V,		470		pF
Crss	Reverse Transfer  Capacitance	f=1MHz		110		Pi
T <sub>D(ON)</sub>	Turn-on delay time			7.5		
Tr	Rise time	VGS=4.5V, RL=1R		6		no
T <sub>D(OFF)</sub>	Turn-off delay time	VDS=10V, RG=1R		32		ns
Tf	Fall time			7		
Q <sub>G</sub>	Total Gate Charge	V00-4 FV VD0 46V		17		
Q <sub>G</sub> s	Gate Source Charge	VGS=4.5V, VDS=10V		6		nC
Q <sub>GD</sub>	Gate Drain Charge	- ID=20A		8		
Trr	Diode Recovery Time	IF=20A, di/dt=100A/us		20		ns
Qrr	Diode Recovery Charge	IF=20A, di/dt=100A/us		30		nC



## **Typical Characteristics**(T<sub>A</sub>=25 °C unless otherwise noted)



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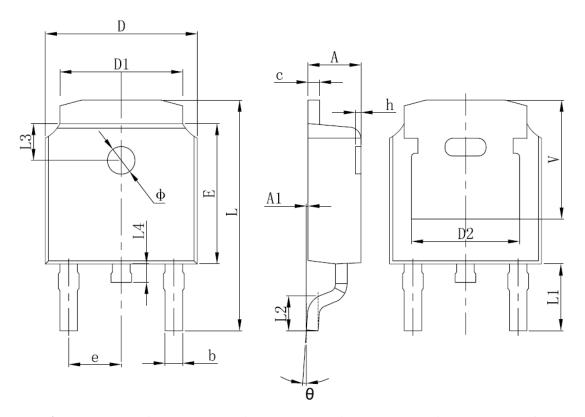
Safe Operating Area

T<sub>J</sub> - Junction Temperature (°C)

On-Resistance vs. Junction Temperature



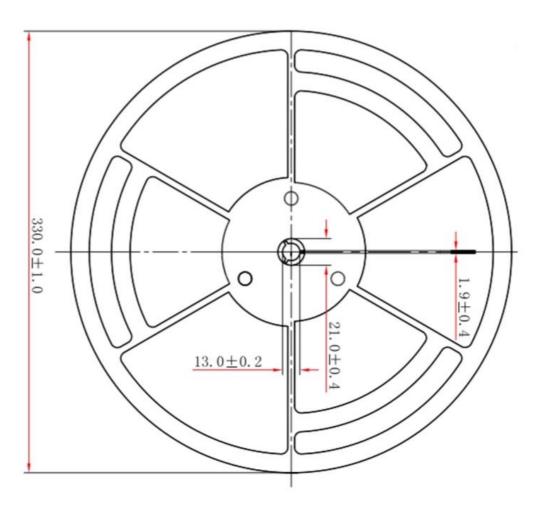
# > Package Information

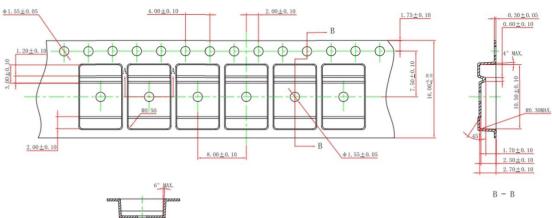


Symbol	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min.	Max.	Min.	Max.
Α	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.635	0.770	0.025	0.030
С	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830	0 REF. 0.190 REF.		REF.
E	6.000	6.200	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.712	10.312	0.382	0.406
L1	2.900	REF.	0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600	REF. 0.063 REF.		REF.
L4	0.600	1.000	0.024	0.039
Ф	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.250 REF.		0.207 REF.	



## Tape and Reel





6,90±0,10



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